Special Issue

New Trends and Advances in Manufacturing Metrology

Message from the Guest Editor

This Special Issue welcomes papers revealing novel measurement methodologies and instrumentations for manufacturing metrology from the conventional industry to the frontiers of the advanced hi-tech industry. We are proud to work with a team of skillful editorial assistants and highly efficient and experienced reviewers. Under our services, your research outcomes can be realized in the production of high-quality papers within a short time. Please submit your manuscripts related to, but not limited to, the following areas:

- Precision dimensional measurements;
- New technology or instruments of on-machine measurements;
- In-process dimensional control or error compensation;
- Machine tool metrology;
- Robot metrology;
- Strategic planning of manufacturing metrology;
- Traceability, uncertainty analysis of measurement systems;

Guest Editor

Prof. Dr. Shivakumar Raman

School of Industrial Engineering, University of Oklahoma, Norman, OK 73019, USA

Deadline for manuscript submissions

closed (15 January 2023)



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Metrology
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
metrology@mdpi.com

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About the Journal

Message from the Editor-in-Chief

Metrology draws together researchers from diverse areas of metrology or measurement technology in a wide variety of applications. I encourage you to submit your manuscripts for consideration or publication in the area of measurement engineering, according to the scope of the journal. Metrology is supported by our authors and their institutes through low article processing charges (APC) for accepted papers. We hope you will support the journal by becoming one of our authors.

Editor-in-Chief

Prof. Dr. Han Haitjema

Department of Mechanical Engineering, KU Leuven, Celestijnenlaan 300, 3001 Leuven, Belgium

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